Electronic Patent Application Fee Transmittal								
Application Number:	10	10615794						
Filing Date:	10	10-Jul-2003						
Title of Invention:		Void-free damascene copper deposition process and means of monitoring thereof						
First Named Inventor/Applicant Name:	Pa	Panayotis Andricacos						
Filer:	Do	Donald K. Drummond/Selena Hamilton						
Attorney Docket Number:	20	20140-00302-US /YOR920030						
Filed as Large Entity								
Utility Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:			•					
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:					1			
Filing a brief in support of an appeal		1402	1	510	510			
Post-Allowance-and-Post-Issuance:								
Extension-of-Time								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			510